

# **Description**

The AOD4185 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a

Battery protection or in other Switching application.

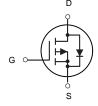


TO252-2L (TO-252(DPAK))

### **General Features**

 $V_{DS} = -40V I_{D} = -40A$ 

 $R_{DS(ON)}$  < 19 m $\Omega$  @  $V_{GS}$ =10V



#### P-Channel MOSFET

# **Application**

Battery protection

Load switch

Uninterruptible power supply

### **Package Marking and Ordering Information**

Product ID	Pack	Marking	Qty(PCS)
AOD4185	TO252-2L(TO-252(DPAK))	40P04 XXX YYYY	2500

### Absolute Maximum Ratings (T<sub>c</sub>=25<sup>°</sup>Cunless otherwise noted)

Symbol	Parameter	Rating	Units		
VDS	Drain-Source Voltage	-40	V		
VGS	Gate-Source Voltage	Sate-Source Voltage ±20			
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	ous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup> -40			
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	ous Drain Current, V <sub>GS</sub> @ 10V¹ -22			
IDM	Pulsed Drain Current <sup>2</sup>	-140	А		
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation <sup>4</sup>	40.3	W		
TSTG	Storage Temperature Range	-55 to 150	°C		
TJ	Operating Junction Temperature Range	-55 to 150	°C		
ReJA	Thermal Resistance Junction-ambient <sup>1</sup>	hermal Resistance Junction-ambient <sup>1</sup> 66			
R₀JC	Thermal Resistance Junction-Case <sup>1</sup>	3.1			



# Electrical Characteristics (T<sub>J</sub> = 25°C, unless otherwise noted)

Parameter		Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static Characteristics			1	<b>,</b>				
Drain-Source Breakdown Voltage		V <sub>(BR)DSS</sub>	$V_{GS} = 0V, I_D = -250\mu A$	-40	-	-	V	
Gate-body Leakage current		Igss	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V	-	-	±100	nA	
Zero Gate Voltage Drain Current	T <sub>J</sub> =25°C	IDSS	V <sub>DS</sub> = -40V, V <sub>GS</sub> = 0V	-	-	-1	μА	
	T <sub>J</sub> =100°C			-	-	-100		
Gate-Threshold Voltage	1	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-1.0	-1.5	-2.2	V	
<u>.                                    </u>		_	V <sub>GS</sub> = -10V, I <sub>D</sub> = -20A	-	13.5	19		
Drain-Source On-Resistance <sup>4</sup>		R <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -15A	-	19.5	25	mΩ	
Forward Transconductance <sup>4</sup>		<b>g</b> fs	V <sub>DS</sub> = -10V, I <sub>D</sub> = -20A	-	44	-	S	
Dynamic Characteristics	5	I	l		l	l	I	
Input Capacitance		C <sub>iss</sub>		-	2525	-		
Output Capacitance		Coss	V <sub>DS</sub> = -20V, V <sub>GS</sub> =0V, f =1MHz	-	190	-	pF	
Reverse Transfer Capacitance		C <sub>rss</sub>	1 111112	-	172	-		
Gate Resistance		Rg	f=1MHz	-	10	-	Ω	
Switching Characteristics	5	I	l		l	l	I	
Total Gate Charge		Qg	V <sub>GS</sub> = -10V,V <sub>DS</sub> = -20V, I <sub>D</sub> = -20A	-	35	-	nC	
Gate-Source Charge		Qgs		-	5.5	-		
Gate-Drain Charge		Q <sub>gd</sub>	- 15 <u> 25 1</u>	-	8	-		
Turn-On Delay Time		t <sub>d(on)</sub>		-	14.5	-	ns	
Rise Time		tr	$V_{GS} = -10V, V_{DD} = -20V,$	-	20.2	_		
Turn-Off Delay Time		t <sub>d(off)</sub>	$R_G = 3\Omega$ , $I_D = -20A$	-	32	_		
Fall Time		tf		-	10	_		
Drain-Source Body Diode	Character	istics	<u> </u>		I	1		
Diode Forward Voltage <sup>4</sup>		V <sub>SD</sub>	I <sub>S</sub> = -20A, V <sub>GS</sub> = 0V		_	-1.2	V	
Continuous Source Current	T <sub>C</sub> =25°C	Is	-	_	_	-40	Α	

#### Note:

- 1. Repetitive rating, pulse width limited by junction temperature  $T_{J(MAX)}$ =150°C.
- 2. The EAS data shows Max. rating . The test condition is  $V_{DD}$ = -25V,  $V_{GS}$ = -10V, L= 0.1mH,  $I_{AS}$ = -34A.
- 3. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
- 4. The data tested by pulsed , pulse width  $\leq 300 us$  , duty cycle  $\leq 2\%.$
- $5. \ This \ value \ is \ guaranteed \ by \ design \ hence \ it \ is \ not \ included \ in \ the \ production \ test.$



# **Typical Characteristics**

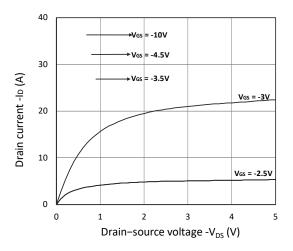


Figure 1. Output Characteristics

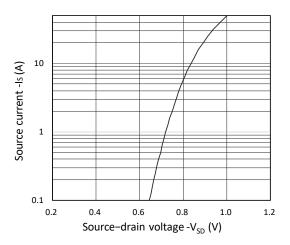


Figure 3. Forward Characteristics of Reverse

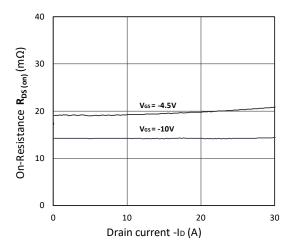


Figure 5.  $R_{DS(ON)}$  vs.  $I_D$ 

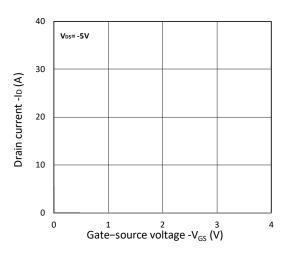


Figure 2. Transfer Characteristics

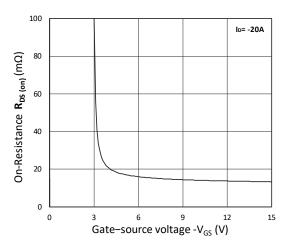


Figure 4.  $R_{DS(ON)}$  vs.  $V_{GS}$ 

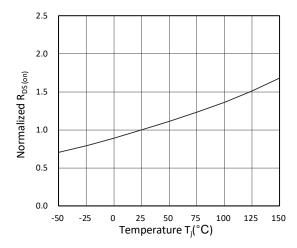


Figure 6. Normalized  $R_{DS(on)}$  vs. Temperature

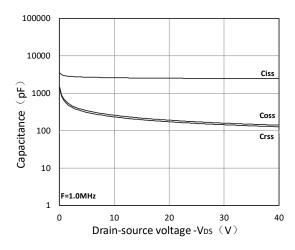


Figure 7. Capacitance Characteristics

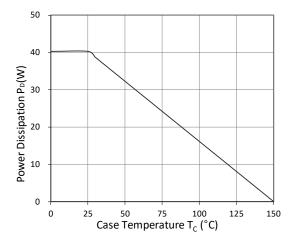


Figure 9. Power Dissipation

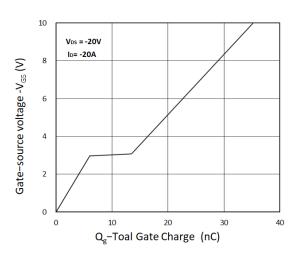


Figure 8. Gate Charge Characteristics

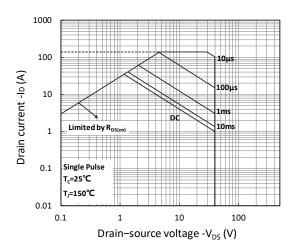


Figure 10. Safe Operating Area

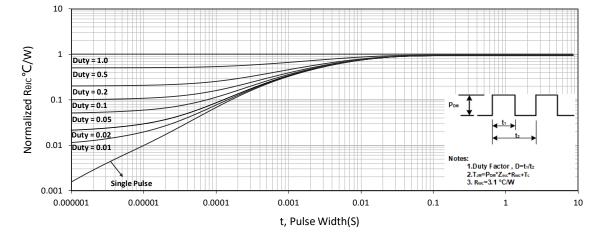


Figure 11. Normalized Maximum Transient Thermal Impedance



## **Test Circuit**

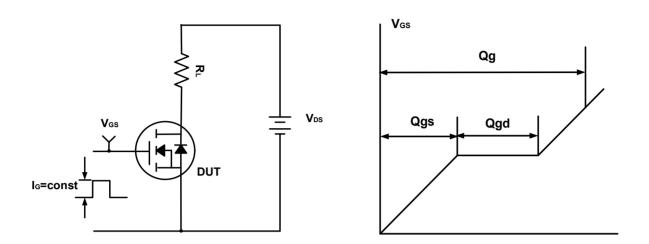


Figure A. Gate Charge Test Circuit & Waveforms

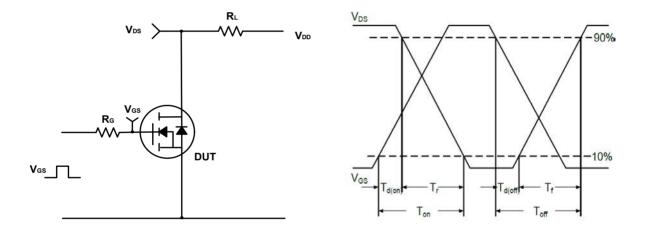


Figure B. Switching Test Circuit & Waveforms

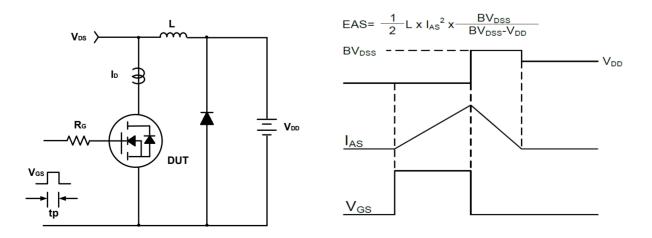
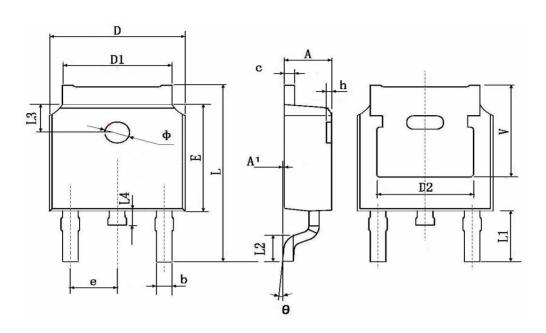


Figure C. Unclamped Inductive Switching Circuit & Waveforms



# TO252-2L(TO-252(DPAK)) Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches			
	Min.	Max.	Min.	Max.		
Α	2.200	2.400	0.087	0.094		
A1	0.000	0.127	0.000	0.005		
b	0.660	0.860	0.026	0.034		
С	0.460	0.580	0.018	0.023		
D	6.500	6.700	0.256	0.264		
D1	5.100	5.460	0.201	0.215		
D2	4.830 TYP.		0.190 TYP.			
E	6.000	6.200	0.236	0.244		
е	2.186	2.386	0.086	0.094		
L	9.800	10.400	0.386	0.409		
L1	2.900 TYP.		0.114 TYP.			
L2	1.400	1.700	0.055	0.067		
L3	1.600	1.600 TYP.		0.063 TYP.		
L4	0.600	1.000	0.024	0.039		
Ф	1.100	1.300	0.043	0.051		
θ	0°	8°	0°	8°		
h	0.000	0.300	0.000	0.012		
V	5.350	TYP.	0.211 TYP.			



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